Product Brief



3G Basestation Processor

3GPP/UMTS Physical Channel Processing

The 3G basestation processor is a single-chip, physical channel processing solution for 3GPP/UMTS Macro, Micro and Pico cell Node B applications. It provides up to 64 customer programmable RAKE receivers and 364 downlink channel resources which may be individually controlled through a Virtual Machine interface. Superior radio link performance can easily be attained with available firmware libraries or can be enhanced with customized implementations. The 3G basestation processor enables design of flexible, data-rate scalable Node B solutions embedding customer proprietary radio link, power control and measurement algorithms.

Features

- Supports 3GPP release 99 and release 4 physical channel processing requirements
- Data-rate scalable channel elements across all spreading factors
- Up to 64 uplink channel elements supporting a variety of receiver structures
- Pool of 384 fingers, configurable as 6-16 finger RAKE receivers
- 9600 MOPS 16-bit embedded dataflow DSP array
- 96 multipath searchers
- 4096-tap access channel preamble detection engine
- 384 downlink channel resources
- Supports up to 12 uplink and downlink antenna ports

Software

- Object-oriented ANSI-C application programming interface for runtime configuration, management and control
 - Virtual machine interface (VMI)
- Embedded firmware development tools for customer proprietary radio link, power control and measurement algorithms
- Embedded firmware library of 3GPP reference algorithms
 - Channel estimation
 - Delayed-locked loop
 - Frequency-locked loop
 - RSCP estimation
 - ISCP estimation
 - UL and DL power control
 - Pilot BER measurement
 - Tx code-power measurement
 - Power-delay profile measurement

Туре	Sales Code	Package
3G Basestation Processor	CBME V1.1 - PMB 9500	P-EBGA-600

www.infineon.com/mobilesolutions

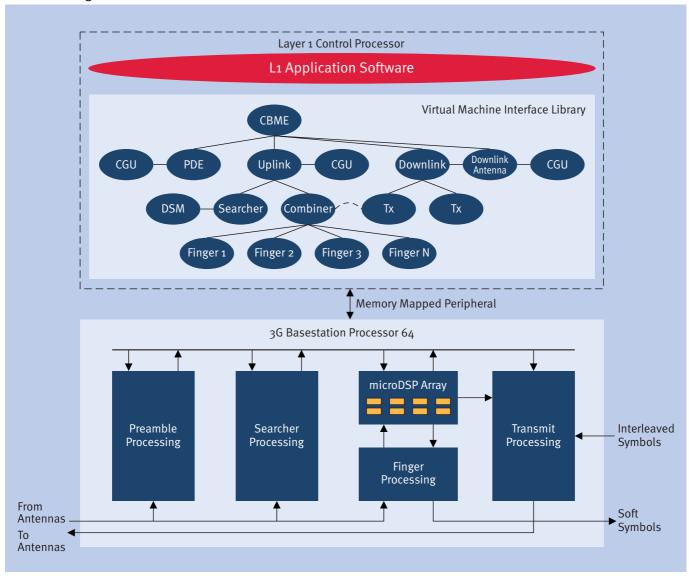
Wireless Communication



Infineon Technologies Morphics Inc.



Block Diagram of CBME V1.1 with Associated VMI



Features

- Channel capacity maintained across:
 - Spreading factors
 - Compressed-mode operation
- Very low latency power control loop
- Pooled resources across antennas and sectors
- Supports N-antenna Rx and Tx diversity
- HSDPA ready

Development Tools

- VMI functional simulator
- microDSP development toolkit
- Hardware development platform

Ordering Information

Please contact Infineon Technologies Morphics, or your local Infineon sales office for additional information about our 3G basestation products

How to reach us: http://www.infineon.com

Published by Infineon Technologies AG, St.-Martin-Strasse 53, D-81669 München

© Infineon Technologies AG 2004. All Rights Reserved.

Template: pb_tmplt.fm/4/2004-01-01

Attention please!

The information herein is given to describe certain components and shall not be considered as a guarantee of characteristics.

Terms of delivery and rights to technical change reserved.

We hereby disclaim any and all warranties, including but not limited to warranties of non-infringement, regarding circuits, descriptions and charts stated herein.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office.

Warnings

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.

Infineon Technologies Components may only be used in lifesupport devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.